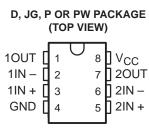
SLOS051C - OCTOBER 1987 - REVISED MAY 1999

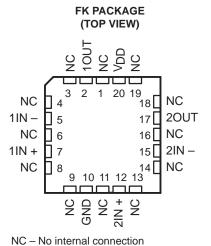
- **Trimmed Offset Voltage:** TLC27M7 . . . 500 μV Max at 25°C, $V_{DD} = 5 V$
- Input Offset Voltage Drift . . . Typically 0.1 μV/Month, Including the First 30 Days
- Wide Range of Supply Voltages Over **Specified Temperature Ranges:**

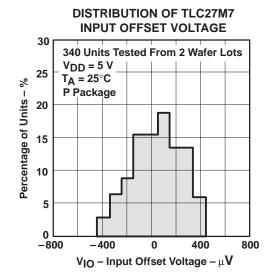
 0° C to 70° C . . . 3 V to 16 V -40°C to 85°C . . . 4 V to 16 V -55°C to 125°C . . . 4 V to 16 V

- **Single-Supply Operation**
- **Common-Mode Input Voltage Range** Extends Below the Negative Rail (C-Suffix, **I-Suffix Types)**

- Low Noise . . . Typically 32 nV/√Hz at f = 1 kHz
- Low Power . . . Typically 2.1 mW at 25°C, $V_{DD} = 5 V$
- **Output Voltage Range Includes Negative**
- High Input impedance . . . $10^{12} \Omega$ Typ
- **ESD-Protection Circuitry**
- **Small-Outline Package Option Also** Available in Tape and Reel
- **Designed-In Latch-Up Immunity**







AVAILABLE OPTIONS

	V may			PACKAGE		
TA	V _{IO} max AT 25°C	SMALL OUTLINE (D)	CHIP CARRIER (FK)	CERAMIC DIP (JG)	PLASTIC DIP (P)	TSSOP (PW)
	500 μV	TLC27M7CD	_	_	TLC27M7CP	_
0°C to 70°C	2 mV	TLC27M2BCD	_	_	TLC27M2BCP	_
0.01070.0	5 mV	TLC27M2ACD	_	_	TLC27M2ACP	_
	10 mV	TLC27M2CD	_	_	TLC27M2CP	TLC27M2CPW
	500 μV	TLC27M7ID	_	_	TLC27M7IP	_
-40°C to 85°C	2 mV	TLC27M2BID	_	_	TLC27M2BIP	_
-40°C 10 85°C	5 mV	TLC27M2AID	_	_	TLC27M2AIP	_
	10 mV	TLC27M2ID	_	_	TLC27M2IP	TLC27M2IPW
-55°C to 125°C	500 μV	TLC27M7MD	TLC27M7MFK	TLC27M7MJG	TLC27M7MP	_
-55°C 10 125°C	10 mV	TLC27M2MD	TLC27M2MFK	TLC27M2MJG	TLC27M2MP	_

The D and PW package is available taped and reeled. Add R suffix to the device type (e.g., TLC27M7CDR).

LinCMOS is a trademark of Texas Instruments Incorporated.



SLOS051C - OCTOBER 1987 - REVISED MAY 1999

description

The TLC27M2 and TLC27M7 dual operational amplifiers combine a wide range of input offset voltage grades with low offset voltage drift, high input impedance, low noise, and speeds approaching that of general-purpose bipolar devices. These devices use Texas Instruments silicon-gate LinCMOS technology, which provides offset voltage stability far exceeding the stability available with conventional metal-gate processes.

The extremely high input impedance, low bias currents, and high slew rates make these cost-effective devices ideal for applications which have previously been reserved for general-purpose bipolar products, but with only a fraction of the power consumption. Four offset voltage grades are available (C-suffix and I-suffix types), ranging from the low-cost TLC27M2 (10 mV) to the high-precision TLC27M7 (500 μ V). These advantages, in combination with good common-mode rejection and supply voltage rejection, make these devices a good choice for new state-of-the-art designs as well as for upgrading existing designs.

In general, many features associated with bipolar technology are available on LinCMOS™ operational amplifiers, without the power penalties of bipolar technology. General applications such as transducer interfacing, analog calculations, amplifier blocks, active filters, and signal buffering are easily designed with the TLC27M2 and TLC27M7. The devices also exhibit low voltage single-supply operation, making them ideally suited for remote and inaccessible battery-powered applications. The common-mode input voltage range includes the negative rail.

A wide range of packaging options is available, including small-outline and chip-carrier versions for high-density system applications.

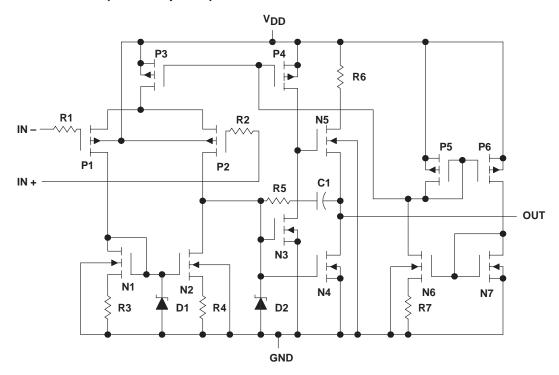
The device inputs and outputs are designed to withstand -100-mA surge currents without sustaining latch-up.

The TLC27M2 and TLC27M7 incorporate internal ESD-protection circuits that prevent functional failures at voltages up to 2000 V as tested under MIL-STD-883C, Method 3015.2; however, care should be exercised in handling these devices as exposure to ESD may result in the degradation of the device parametric performance.

The C-suffix devices are characterized for operation from 0° C to 70° C. The I-suffix devices are characterized for operation from -40° C to 85° C. The M-suffix devices are characterized for operation over the full military temperature range of -55° C to 125° C.



equivalent schematic (each amplifier)



SLOS051C - OCTOBER 1987 - REVISED MAY 1999

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V _{DD} (see Note 1)	18 V
Differential input voltage, V _{ID} (see Note 2)	±V _{DD}
Input voltage range, V _I (any input)	$\dots \dots - 0.3 \text{ V to V}_{DD}$
Input current, I ₁	
Output current, I _O (each output)	$\dots \dots \pm 30 \; \text{mA}$
Total current into V _{DD}	45 mA
Total current out of GND	45 mA
Duration of short-circuit current at (or below) 25°C (see Note 3)	Unlimited
Continuous total dissipation	See Dissipation Rating Table
Operating free-air temperature, T _A : C suffix	0°C to 70°C
I suffix	
M suffix	–55°C to 125°C
Storage temperature range	65°C to 150°C
Case temperature for 60 seconds: FK package	260°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds: D or P packa	ge 260°C
Lead temperature 1,6 mm (1/16 inch) from case for 60 seconds: JG package	300°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltage values, except differential voltages, are with respect to network ground.
 - 2. Differential voltages are at IN+ with respect to IN-.
 - 3. The output may be shorted to either supply. Temperature and/or supply voltages must be limited to ensure that the maximum dissipation rating is not exceeded (see application section).

DISSIPATION RATING TABLE

PACKAGE	$\begin{aligned} & \textbf{T}_{\pmb{A}} \leq \textbf{25}^{\circ}\textbf{C} \\ & \textbf{POWER RATING} \end{aligned}$	DERATING FACTOR ABOVE T _A = 25°C	T _A = 70°C POWER RATING	T _A = 85°C POWER RATING	T _A = 125°C POWER RATING
D	725 mW	5.8 mW/°C	464 mW	377 mW	
FK	1375 mW	11.0 mW/°C	880 mW	715 mW	275 mW
JG	1050 mW	8.4 mW/°C	672 mW	546 mW	210 mW
Р	1000 mW	8.0 mW/°C	640 mW	520 mW	

recommended operating conditions

		C SU	FFIX	I SUF	FIX	M SU	FFIX	UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	UNIT
Supply voltage, V _{DD}		3	16	4	16	4	16	V
Common mode input voltage V	V _{DD} = 5 V	-0.2	3.5	-0.2	3.5	0	3.5	V
Common-mode input voltage, V _{IC}	V _{DD} = 10 V	-0.2	8.5	-0.2	8.5	0	8.5	V
Operating free-air temperature, TA		0	70	-40	85	-55	125	°C



SLOS051C - OCTOBER 1987 - REVISED MAY 1999

electrical characteristics at specified free-air temperature, V_{DD} = 5 V (unless otherwise noted)

	PARAMETER		TEST CON	DITIONS	T _A †	TL TL	.C27M2 .C27M2 .C27M2 .C27M7	AC BC	UNIT
						MIN	TYP	MAX	
		TLC27M2C	V _O = 1.4 V,	V _{IC} = 0,	25°C		1.1	10	
		TEGZ/WZC	$R_S = 50 \Omega$,	$R_I = 100 \text{ k}\Omega$	Full range			12	mV
		TLC27M2AC	V _O = 1.4 V,	V _{IC} = 0,	25°C		0.9	5	IIIV
VIO	Input offset voltage	TEGZTWIZAC	$R_S = 50 \Omega$,	$R_I = 100 \text{ k}\Omega$	Full range			6.5	
V10	input onset voltage	TLC27M2BC	V _O = 1.4 V,	$V_{IC} = 0$,	25°C		220	2000	
		TEGZTWIZBC	$R_S = 50 \Omega$,	$R_{\parallel} = 100 \text{ k}\Omega$	Full range			3000	μV
		TLC27M7C	V _O = 1.4 V,	$V_{IC} = 0$,	25°C		185	500	μν
		TLOZIWITO	$R_S = 50 \Omega$,	$R_I = 100 \text{ k}\Omega$	Full range			1500	
α_{VIO}	Average temperature confiset voltage	pefficient of input			25°C to 70°C		1.7		μV/°C
	lanut effect coment (co.	Note 4)	V 05V	V 05V	25°C		0.1		Δ
liO	Input offset current (see	e Note 4)	$V_0 = 2.5 V,$	$V_{IC} = 2.5 V$	70°C		7	300	pΑ
	Laurent Indian accommend da a a	NI-1- 4)	V 05V		25°C		0.6		·- A
IB	Input bias current (see	Note 4)	$V_0 = 2.5 V$,	$V_{IC} = 2.5 V$	70°C		40	600	pΑ
.,	Common-mode input vo	oltage range			25°C	-0.2 to 4	-0.3 to 4.2		V
VICR	(see Note 5)				Full range	-0.2 to 3.5			V
					25°C	3.2	3.9		
Vон	High-level output voltag	je	$V_{ID} = 100 \text{ mV},$	$R_L = 100 \text{ k}\Omega$	0°C	3	3.9		V
					70°C	3	4		
					25°C		0	50	
VOL	Low-level output voltag	е	$V_{ID} = -100 \text{ mV},$	IOL = 0	0°C		0	50	mV
					70°C		0	50	
	Laura alau - Latter - C. C.				25°C	25	170		
AVD	Large-signal differential amplification	voitage	$V_0 = 0.25 \text{ V to 2 V},$	$R_L = 100 \text{ k}\Omega$	0°C	15	200		V/mV
					70°C	15	140		
					25°C	65	91		
CMRR	Common-mode rejection	n ratio	V _{IC} = V _{ICR} min		0°C	60	91		dB
					70°C	60	92		
	Cumply voltage raise!	- rotio			25°C	70	93		
kSVR	Supply-voltage rejection (ΔV _{DD} /ΔV _{IO})	i rauo	$V_{DD} = 5 \text{ V to } 10 \text{ V},$	$V_0 = 1.4 \text{ V}$	0°C	60	92		dB
	\ DD: 10/				70°C	60	94		
			Vo = 2.5.V	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	25°C		210	560	
I_{DD}	Supply current (two am	plifiers)	V _O = 2.5 V, No load	$V_{IC} = 2.5 V,$	0°C		250	640	μΑ
					70°C		170	440	

[†] Full range is 0°C to 70°C.

NOTES: 4. The typical values of input bias current and input offset current below 5 pA were determined mathematically.



^{5.} This range also applies to each input individually.

SLOS051C - OCTOBER 1987 - REVISED MAY 1999

electrical characteristics at specified free-air temperature, V_{DD} = 10 V (unless otherwise noted)

	PARAMETER		TEST CON	DITIONS	τ _A †	TL TL TL	.C27M2 .C27M2 .C27M2 .C27M7	AC BC C	UNIT
		 				MIN	TYP	MAX	
		TLC27M2C	V _O = 1.4 V,	$V_{IC} = 0$,	25°C		1.1	10	
			$R_S = 50 \Omega$,	$R_L = 100 \text{ k}\Omega$	Full range			12	mV
		TLC27M2AC	V _O = 1.4 V,	V _{IC} = 0,	25°C		0.9	5	
VIO	Input offset voltage		$R_S = 50 \Omega$,	$R_L = 100 \text{ k}\Omega$	Full range			6.5	
		TLC27M2BC	V _O = 1.4 V,	$V_{IC} = 0$,	25°C		224	2000	
			$R_S = 50 \Omega$,	$R_L = 100 \text{ k}\Omega$	Full range			3000	μV
		TLC27M7C	$V_0 = 1.4 \text{ V},$	$V_{IC} = 0$,	25°C		190	800	ļ .
			$R_S = 50 \Omega$,	$R_L = 100 \text{ k}\Omega$	Full range			1900	
αVIO	Average temperature coe offset voltage	efficient of input			25°C to 70°C		2.1		μV/°C
lio.	Input offset current (see I	Note 4)	V _O = 5 V,	V _{IC} = 5 V	25°C		0.1		pА
IO	input onset current (see i	NOIE 4)	VO = 3 V,	AIC = 2 A	70°C		7	300	PΑ
lum.	Input bigg ourrent (see N	oto 4)	V _O = 5 V,	\/.o - F \/	25°C		0.7		n^
ΙΒ	Input bias current (see N	ote 4)	VO = 2V	$V_{IC} = 5 V$	70°C		50	600	pΑ
	Common-mode input vol	tage range			25°C	-0.2 to 9	-0.3 to 9.2		V
VICR	(see Note 5)				Full range	-0.2 to 8.5			V
					25°C	8	8.7		
Vон	High-level output voltage		$V_{ID} = 100 \text{ mV},$	$R_L = 100 \text{ k}\Omega$	0°C	7.8	8.7		V
					70°C	7.8	8.7		
					25°C		0	50	
VOL	Low-level output voltage		$V_{ID} = -100 \text{ mV},$	$I_{OL} = 0$	0°C		0	50	mV
					70°C		0	50	
					25°C	25	275		
A _{VD}	Large-signal differential v amplification	roltage	$V_0 = 1 \text{ V to 6 V},$	$R_L = 100 \text{ k}\Omega$	0°C	15	320		V/mV
1	amplification				70°C	15	230		
					25°C	65	94		
CMRR	Common-mode rejection	ratio	V _{IC} = V _{ICR} min		0°C	60	94		dB
1					70°C	60	94		
					25°C	70	93		
ksvr	Supply-voltage rejection	ratio	$V_{DD} = 5 \text{ V to } 10 \text{ V},$	V _O = 1.4 V	0°C	60	92		dB
	$(\Delta V_{DD}/\Delta V_{IO})$			-	70°C	60	94		1
					25°C		285	600	
I _{DD}	Supply current (two ampl	ifiers)	V _O = 5 V, No load	$V_{IC} = 5 V$	0°C		345	800	μΑ
1	•		Two load		70°C		220	560	

[†] Full range is 0°C to 70°C.

NOTES: 4. The typical values of input bias current and input offset current below 5 pA were determined mathematically.

5. This range also applies to each input individually.



SLOS051C - OCTOBER 1987 - REVISED MAY 1999

electrical characteristics at specified free-air temperature, V_{DD} = 5 V (unless otherwise noted)

	PARAMETER		TEST CON	DITIONS	T _A †	TL TL	.C27M2l .C27M2 .C27M2l .C27M7l	AI BI	UNIT
						MIN	TYP	MAX	
		TLC27M2I	$V_0 = 1.4 V$	$V_{IC} = 0$,	25°C		1.1	10	
		TEOZTWIZI	$R_S = 50 \Omega$,	$R_L = 100 \text{ k}\Omega$	Full range			13	mV
		TLC27M2AI	$V_0 = 1.4 V$	$V_{IC} = 0$,	25°C		0.9	5	111 V
VIO	Input offset voltage	TEOZTWIZA	$R_S = 50 \Omega$,	$R_L = 100 \text{ k}\Omega$	Full range			7	
1 10	input onset voltage	TLC27M2BI	$V_0 = 1.4 V$	$V_{IC} = 0$,	25°C		220	2000	
		TEOZYWIZBI	$R_S = 50 \Omega$,	$R_L = 100 \text{ k}\Omega$	Full range			3500	μV
		TLC27M7I	$V_0 = 1.4 V$	$V_{IC} = 0$,	25°C		185	500	μν
		TEGETIVITI	$R_S = 50 \Omega$,	$R_L = 100 \text{ k}\Omega$	Full range			2000	
αVIO	Average temperature coe offset voltage	efficient of input			25°C to 85°C		1.7		μV/°C
		Mata 4)	V 0.5.V		25°C		0.1		·- A
lio	Input offset current (see	Note 4)	$V_0 = 2.5 \text{ V},$	$V_{IC} = 2.5 V$	85°C		24	1000	pΑ
	Lament hilana assumanat Valana Ni	-1- 1	V 0.5.V		25°C		0.6		^
ΙΒ	Input bias current (see N	ote 4)	$V_0 = 2.5 V$,	$V_{IC} = 2.5 V$	85°C		200	2000	pΑ
	Common-mode input vol	tage range			25°C	-0.2 to 4	-0.3 to 4.2		V
VICR	(see Note 5)	age range			Full range	-0.2 to 3.5			V
					25°C	3.2	3.9		
∨он	High-level output voltage		$V_{ID} = 100 \text{ mV},$	$R_L = 100 \text{ k}\Omega$	-40°C	3	3.9		V
					85°C	3	4		
					25°C		0	50	
VOL	Low-level output voltage		$V_{ID} = -100 \text{ mV},$	$I_{OL} = 0$	−40°C		0	50	mV
					85°C		0	50	
					25°C	25	170		
A _{VD}	Large-signal differential vamplification	roltage	$V_O = 0.25 \text{ V to 2 V},$	$R_L = 100 \text{ k}\Omega$	−40°C	15	270		V/mV
	шприновноп				85°C	15	130		
					25°C	65	91		
CMRR	Common-mode rejection	ratio	V _{IC} = V _{ICR} min		−40°C	60	90		dB
					85°C	60	90		
	0 1 1				25°C	70	93		
ksvr	Supply-voltage rejection (ΔV _{DD} /ΔV _{IO})	ratio	$V_{DD} = 5 \text{ V to } 10 \text{ V},$	$V_0 = 1.4 \text{ V}$	−40°C	60	91		dB
	\-`\UU'\UU				85°C	60	94		
			V- 251	V 05V	25°C		210	560	
I _{DD}	Supply current (two amp	ifiers)	V _O = 2.5 V, No load	$V_{IC} = 2.5 V,$	−40°C		315	800	μΑ
					85°C		160	400	

[†] Full range is –40°C to 85°C.

NOTES: 4. The typical values of input bias current and input offset current below 5 pA were determined mathematically.



^{5.} This range also applies to each input individually.

SLOS051C - OCTOBER 1987 - REVISED MAY 1999

electrical characteristics at specified free-air temperature, V_{DD} = 10 V (unless otherwise noted)

	PARAMETER		TEST CONI	DITIONS	Τ _Α †	TI TI	C27M2 C27M2 C27M2 C27M2	AI BI I	UNIT
						MIN	TYP	MAX	
		TLC27M2I	$V_0 = 1.4 \text{ V},$	$V_{IC} = 0,$	25°C		1.1	10	
			$R_S = 50 \Omega$,	$R_L = 100 \text{ k}\Omega$	Full range			13	mV
		TLC27M2AI	V _O = 1.4 V,	$V_{IC} = 0$,	25°C		0.9	5	
VIO	Input offset voltage		$R_S = 50 \Omega$,	$R_L = 100 \text{ k}\Omega$	Full range			7	
.0		TLC27M2BI	V _O = 1.4 V,	$V_{IC} = 0$,	25°C		224	2000	
			$R_S = 50 \Omega$	$R_L = 100 \text{ k}\Omega$	Full range			3500	μV
		TLC27M7I	$V_0 = 1.4 \text{ V},$	$V_{IC} = 0$,	25°C		190	800	·
			$R_S = 50 \Omega$,	$R_L = 100 \text{ k}\Omega$	Full range			2900	
αVIO	Average temperature coeffice offset voltage	cient of input			25°C to 85°C		2.1		μV/°C
lio.	Input offset current (see No	te 4)	V _O = 5 V,	V _{IC} = 5 V	25°C		0.1		рA
lio	input onset current (see No	10 4)	VO = 5 V,	VIC = 3 V	85°C		26	1000	PΛ
					25°C		0.7		
I _{IB}	Input bias current (see Note	e 4)	$V_0 = 5 V$,	$V_{IC} = 5 V$	85°C		220	200 0	pA
V	Common-mode input voltag	je range			25°C	-0.2 to 9	-0.3 to 9.2		V
VICR	(see Note 5)	· ·			Full range	-0.2 to 8.5			V
					25°C	8	8.7		
Vон	High-level output voltage		$V_{ID} = 100 \text{ mV},$	$R_L = 100 \text{ k}\Omega$	-40°C	7.8	8.7		V
					85°C	7.8	8.7		
					25°C		0	50	
VOL	Low-level output voltage		$V_{ID} = -100 \text{ mV},$	$I_{OL} = 0$	-40°C		0	50	mV
					85°C		0	50	
					25°C	25	275		
A_{VD}	Large-signal differential volt amplification	age	$V_0 = 1 \text{ V to 6 V},$	$R_L = 100 \text{ k}\Omega$	−40°C	15	390		V/mV
	amplification				85°C	15	220		
					25°C	65	94		
CMRR	Common-mode rejection ra	tio	V _{IC} = V _{ICR} min		-40°C	60	93		dB
					85°C	60	94		
					25°C	70	93		
k _{SVR}	Supply-voltage rejection rat (ΔV _{DD} /ΔV _{IO})	10	$V_{DD} = 5 \text{ V to } 10 \text{ V},$	$V_0 = 1.4 \text{ V}$	-40°C	60	91		dB
	(= * DD				85°C	60	94		
					25°C		285	600	
I_{DD}	Supply current		V _O = 5 V, No load	$V_{IC} = 5 V$	-40°C		450	900	μΑ
					85°C		205	520	

[†]Full range is -40°C to 85°C.

NOTES: 4. The typical values of input bias current and input offset current below 5 pA were determined mathematically.

^{5.} This range also applies to each input individually.



SLOS051C - OCTOBER 1987 - REVISED MAY 1999

electrical characteristics at specified free-air temperature, V_{DD} = 5 V (unless otherwise noted)

	PARAMETER		TEST CONI	DITIONS	T _A †		.C27M2I		UNIT
					^	MIN	TYP	MAX	
		TI COZNONA	V _O = 1.4 V,	V _{IC} = 0,	25°C		1.1	10	
M	land offert wells as	TLC27M2M	$R_S = 50 \Omega$,	$R_L = 100 \text{ k}\Omega$	Full range			12	>/
VIO	Input offset voltage	TI 007N7N4	V _O = 1.4 V,	V _{IC} = 0,	25°C		185	500	mV
		TLC27M7M	$R_S = 50 \Omega$	$R_L = 100 \text{ k}\Omega$	Full range			3750	
αVIO	Average temperature coeffi offset voltage	cient of input			25°C to 125°C		1.7		μV/°C
	Leavet effect comment (e.e. No	(- A)	V 05V		25°C		0.1		рА
IIO	Input offset current (see No	ite 4)	$V_0 = 2.5 V$,	$V_{IC} = 2.5 V$	125°C		1.4	15	nA
			.,	.,	25°C		0.6		pА
ΙΒ	Input bias current (see Note	e 4)	$V_0 = 2.5 V$,	$V_{IC} = 2.5 V$	125°C		9	35	nA
W	Common-mode input voltage	ge range			25°C	0 to 4	-0.3 to 4.2		V
VICR	(see Note 5)				Full range	0 to 3.5			V
					25°C	3.2	3.9		
Vон	High-level output voltage		$V_{ID} = 100 \text{ mV},$	$R_L = 100 \text{ k}\Omega$	−55°C	3	3.9		V
					125°C	3	4		
					25°C		0	50	
V_{OL}	Low-level output voltage		$V_{ID} = -100 \text{ mV},$	$I_{OL} = 0$	−55°C		0	50	mV
					125°C		0	50	
					25°C	25	170		
A_{VD}	Large-signal differential vol amplification	tage	$V_0 = 0.25 \text{ V to 2 V},$	$R_L = 100 \text{ k}\Omega$	−55°C	15	290		V/mV
	amplification				125°C	15	120		
					25°C	65	91		
CMRR	Common-mode rejection ra	itio	V _{IC} = V _{ICR} min		−55°C	60	89		dB
					125°C	60	91		
					25°C	70	93		
ksvr	Supply-voltage rejection ra (ΔVDD/ΔVIO)	tio	$V_{DD} = 5 \text{ V to } 10 \text{ V},$	$V_0 = 1.4 \text{ V}$	−55°C	60	91		dB
	(A) DD/A) (O)				125°C	60	94		
			V 05V		25°C		210	560	
I_{DD}	Supply current (two amplific	ers)	V _O = 2.5 V, No load	$V_{IC} = 2.5 V,$	−55°C		340	880	μΑ
			110 1000		125°C		140	360	

[†] Full range is –55°C to 125°C.

NOTES: 4. The typical values of input bias current and input offset current below 5 pA were determined mathematically.

5. This range also applies to each input individually.



SLOS051C - OCTOBER 1987 - REVISED MAY 1999

electrical characteristics at specified free-air temperature, $V_{\mbox{\scriptsize DD}}$ = 10 V (unless otherwise noted)

	PARAMETER		TEST CONI	DITIONS	T _A †		.C27M2N .C27M7N		UNIT
					^	MIN	TYP	MAX	
		TLC27M2M	V _O = 1.4 V,	V _{IC} = 0,	25°C		1.1	10	
\/	lanut effect valence	I LC2/M2M	$R_S = 50 \Omega$,	$R_L = 100 \text{ k}\Omega$	Full range			12	>/
VIO	Input offset voltage	TI COZNAZNA	V _O = 1.4 V,	V _{IC} = 0,	25°C		190	800	mV
		TLC27M7M	$R_S = 50 \Omega$,	$R_L = 100 \text{ k}\Omega$	Full range			4300	
αΛΙΟ	Average temperature coeffice offset voltage	ient of input			25°C to 125°C		2.1		μV/°C
I	lancet offert comment (see Net	- 4\	V- 5V	\\ F\\	25°C		0.1		A
IO	Input offset current (see Not	e 4)	V _O = 5 V,	$V_{IC} = 5 V$	125°C		1.8	15	pΑ
	land his a summer for a Net-	4)	V 5V		25°C		0.7		A
ΙΒ	Input bias current (see Note	4)	V _O = 5 V,	$V_{IC} = 5 V$	125°C		10	35	pΑ
\\	Common-mode input voltage	e range			25°C	0 to 9	-0.3 to 9.2		V
VICR	(see Note 5)	-			Full range	0 to 8.5			V
					25°C	8	8.7		
Vон	High-level output voltage		$V_{ID} = 100 \text{ mV},$	$R_L = 100 \text{ k}\Omega$	−55°C	7.8	8.6		V
					125°C	7.8	8.8		
					25°C		0	50	
VOL	Low-level output voltage		$V_{ID} = -100 \text{ mV},$	IOF = 0	−55°C		0	50	mV
					125°C		0	50	
					25°C	25	275		
AVD	Large-signal differential volta amplification	age	$V_0 = 1 \text{ V to 6 V},$	$R_L = 100 \text{ k}\Omega$	−55°C	15	420		V/mV
	amplification				125°C	15	190		
					25°C	65	94		
CMRR	Common-mode rejection rat	io	$V_{IC} = V_{ICR}min$		−55°C	60	93		dB
					125°C	60	93		
		<u> </u>			25°C	70	93		
ksvr	Supply-voltage rejection ration (ΔVDD/ΔVIO)	0	$V_{DD} = 5 \text{ V to } 10 \text{ V},$	$V_0 = 1.4 \text{ V}$	−55°C	60	91		dB
	(\(\text{\Omega}\D\)\(\text{\Omega}\D\)				125°C	60	94		
			, 5V		25°C		285	600	
I_{DD}	Supply current (two amplifie	rs)	V _O = 5 V, No load	$V_{IC} = 5 V$	−55°C		490	1000	μΑ
			110 1000		125°C		180	480	

[†] Full range is –55°C to 125°C.

NOTES: 4. The typical values of input bias current and input offset current below 5 pA were determined mathematically.

5. This range also applies to each input individually.

operating characteristics at specified free-air temperature, $V_{DD} = 5 \text{ V}$

	PARAMETER	TEST CO	ONDITIONS	TA	TLC TLC	27M2C 27M2A 27M2B 27M7C	C C	UNIT
					MIN	TYP	MAX	
				25°C		0.43		
1			V _{I(PP)} = 1 V	0°C		0.46		
SR	Slew rate at unity gain	$R_L = 100 \text{ k}\Omega$		70°C		0.36		V/μs
	Siew rate at unity gain	C _L = 20 pF, See Figure 1		25°C		0.40		ν/μδ
1			$V_{I(PP)} = 2.5 V$	0°C		0.43		
				70°C		0.34		
Vn	Equivalent input noise voltage	f = 1 kHz, See Figure 2	$R_S = 20 \Omega$,	25°C		32		nV/√ Hz
				25°C		55		
ВОМ	Maximum output-swing bandwidth	$V_O = V_{OH}$, $R_L = 100 \text{ k}\Omega$,	C _L = 20 pF, See Figure 1	0°C		60		kHz
			occ rigure r	70°C		50		
		.,		25°C		525		
B ₁	Unity-gain bandwidth	V _I = 10 mV, See Figure 3	$C_L = 20 pF$,	0°C		600		kHz
		See rigule 3		70°C		400]
		V 40V	, ,	25°C		40°		
φm	Phase margin	$V_{I} = 10 \text{ mV},$	$V_I = 10 \text{ mV}, \qquad f = B_1,$ $C_L = 20 \text{ pF}, \qquad \text{See Figure 3}$	0°C	41°			
		Σ 20 βι,	23353100	70°C		39°		

operating characteristics at specified free-air temperature, V_{DD} = 10 V

	PARAMETER	TEST C	ONDITIONS	TA	TLC TLC	27M2C 27M2A 27M2B 27M7C	C	UNIT
					MIN	TYP	MAX	
				25°C		0.62		
			V _{I(PP)} = 1 V	0°C		0.67		
SR	Slew rate at unity gain	$R_L = 100 \text{ k}\Omega$		70°C		0.51		V/μs
JSK	Siew rate at utility gain	C _L = 20 pF, See Figure 1		25°C		0.56		ν/μ5
			V _{I(PP)} = 5.5 V	0°C		0.61		
				70°C		0.46		
Vn	Equivalent input noise voltage	f = 1 kHz, See Figure 2	$R_S = 20 \Omega$,	25°C		32		nV/√ Hz
				25°C		35		
ВОМ	Maximum output-swing bandwidth	$V_O = V_{OH}$, $R_L = 100 \text{ k}\Omega$,	C _L = 20 pF, See Figure 1	0°C		40		kHz
			Gee rigure r	70°C		30		
				25°C		635		
B ₁	Unity-gain bandwidth	V _I = 10 mV, See Figure 3	$C_L = 20 pF$,	0°C		710		kHz
		See rigule 3		70°C		510		
		.,,		25°C		43°		
φm	Phase margin	V _I = 10 mV, C _L = 20 pF,	f = B ₁ , See Figure 3	0°C		44°		
		OL - 20 pr,		70°C		42°		

SLOS051C - OCTOBER 1987 - REVISED MAY 1999

operating characteristics at specified free-air temperature, $V_{DD} = 5 V$

PARAMETER		TEST CO	TA	TLC27M2I TLC27M2AI TLC27M2BI TLC27M7I		UNIT			
				MIN	TYP	MAX	1		
				25°C		0.43			
			1 1(11)	0.51		1			
SR	Slew rate at unity gain	$R_L = 100 \text{ k}\Omega$		85°C		0.35		V/μs	
	Siew rate at unity gain	C _L = 20 pF, See Figure 1		25°C		0.40		ν/μ5	
	$V_{I(PP)} = 2.5 \text{ V}$ -40°C 85°C	0.48							
				85°C		0.32			
Vn	Equivalent input noise voltage	f = 1 kHz, See Figure 2	$R_S = 20 \Omega$,	25°C		32		nV/√ Hz	
		$V_O = V_{OH},$ $R_L = 100 \text{ k}\Omega,$		25°C		55			
ВОМ	Maximum output-swing bandwidth		C _L = 20 pF, See Figure 1	−40°C		75		kHz	
			occ riguic r	85°C		45		1	
				25°C		525		MHz	
B ₁	Unity-gain bandwidth	V _I = 10 mV, See Figure 3	$C_L = 20 pF$,	−40°C		770			
		See Figure 3		85°C		370			
		V _I = 10 mV, C _L = 20 pF,	, D	25°C		40°			
φm	Phase margin		f = B ₁ , See Figure 3	−40°C		43°		1	
		0L - 20 pi,	2331 194100	85°C		38°			

operating characteristics at specified free-air temperature, V_{DD} = 10 V

PARAMETER		TEST CO	TA	TLC27M2I TLC27M2AI TLC27M2BI TLC27M7I		UNIT			
						TYP	MAX		
				25°C		0.62		l l	
			$V_{I(PP)} = 1 V$	−40°C	0.77				
SR	Slew rate at unity gain	$R_L = 100 \text{ k}\Omega$		85°C		0.47		\////	
J SK	Siew rate at utility gain	C _L = 20 pF, See Figure 1		25°C		0.56	\	V/μs	
		3	V _{I(PP)} = 5.5 V	−40°C		0.70			
				85°C		0.44			
Vn	Equivalent input noise voltage	f = 1 kHz, See Figure 2	$R_S = 20 \Omega$,	25°C		32		nV/√ Hz	
	Maximum output-swing bandwidth	$V_O = V_{OH},$ $R_L = 100 \text{ k}\Omega,$		25°C		35			
ВОМ			C _L = 20 pF, See Figure 1	−40°C		45		kHz	
			Gee rigure r	85°C		25		1	
		V _I = 10 mV, See Figure 3		25°C		635			
В1	Unity-gain bandwidth		$C_L = 20 pF$,	−40°C		880		MHz	
				85°C		480		1	
		V 40 V	. 5	25°C		43°			
φm	Phase margin	V _I = 10 mV, C _L = 20 pF,	f = B ₁ , See Figure 3	−40°C		46°]	
				85°C		41°			

SLOS051C - OCTOBER 1987 - REVISED MAY 1999

operating characteristics at specified free-air temperature, $V_{DD} = 5 V$

PARAMETER		TEST CO	ONDITIONS	TA	TLC27M2M TLC27M7M			UNIT
					MIN	TYP	MAX	
				25°C		0.43		
			V _{I(PP)} = 1 V	−55°C		0.54		
CD.	Class rate at units agin		C _L = 20 pF,	0.29		V/μs		
SR	Slew rate at unity gain	See Figure 1		0.40				
			$V_{I(PP)} = 2.5 \text{ V}$	−55°C	55°C 0.49			
				125°C		0.28		
Vn	Equivalent input noise voltage	f = 1 kHz, See Figure 2	$R_S = 20 \Omega$,	25°C		32		nV/√ Hz
				25°C		55		
ВОМ	Maximum output-swing bandwidth	$V_O = V_{OH}$, $R_L = 100 \text{ k}\Omega$,	C _L = 20 pF,	−55°C		80		kHz
			Occ rigare r	125°C		40		1
			_	25°C		525		
B ₁	Unity-gain bandwidth		$C_L = 20 pF$,	−55°C		850		kHz
		See Figure 3		125°C		330		
		V 40 V	, 5	25°C		40°		
φm	Phase margin	$V_{I} = 10 \text{ mV},$ $C_{L} = 20 \text{ pF}$	f = B ₁ , See Figure 3	−55°C		44°		1
		- 20 pr,	223 . iga. 3	125°C		36°		

operating characteristics at specified free-air temperature, V_{DD} = 10 V

PARAMETER		TEST CO	ONDITIONS	TA	TLC27M2M TLC27M7M			UNIT	
					MIN	TYP	MAX		
				25°C		0.62			
			V _{I(PP)} = 1 V	−55°C		0.81]	
SR	Claus rate at units ania	$R_L = 100 \text{ k}\Omega$		125°C 0.38		\//··a			
SK	Slew rate at unity gain	C _L = 20 pF, See Figure 1		25°C		0.56		V/μs	
			$V_{I(PP)} = 5.5 \text{ V}$	−55°C	0.73]		
				125°C		0.35			
V _n	Equivalent input noise voltage	f = 1 kHz, See Figure 2	$R_S = 20 \Omega$,	25°C		32		nV/√ Hz	
			$C_{L} = 20 \text{ pF},$ $C_{L} $	25°C		35			
ВОМ	Maximum output-swing bandwidth	VO = VOH,			kHz				
				125°C		20]	
				25°C		635		kHz	
В1	Unity gain bandwidth	V _I = 10 mV, See Figure 3	$C_L = 20 pF$,	−55°C		960			
		See Figure 3		125°C		440			
)/ 40 ···)/	(5	25°C		43°			
φm	Phase margin $ V_{l} = 10 \text{ mV}, $ $ C_{L} = 20 \text{ pF}, $	f = B ₁ , See Figure 3	−55°C		47°]		
		0L = 20 pr,	Soo i iguic s	125°C		39°		1	

PARAMETER MEASUREMENT INFORMATION

single-supply versus split-supply test circuits

Because the TLC27M2 and TLC27M7 are optimized for single-supply operation, circuit configurations used for the various tests often present some inconvenience since the input signal, in many cases, must be offset from ground. This inconvenience can be avoided by testing the device with split supplies and the output load tied to the negative rail. A comparison of single-supply versus split-supply test circuits is shown below. The use of either circuit gives the same result.

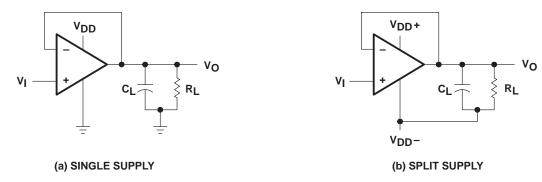


Figure 1. Unity-Gain Amplifier

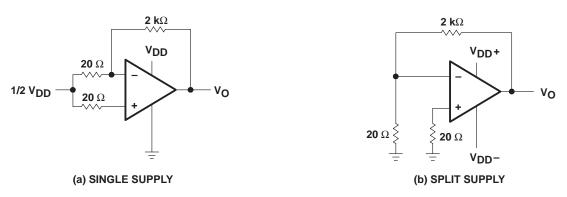


Figure 2. Noise-Test Circuit

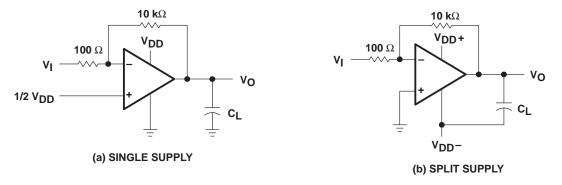


Figure 3. Gain-of-100 Inverting Amplifier

PARAMETER MEASUREMENT INFORMATION

input bias current

Because of the high input impedance of the TLC27M2 and TLC27M7 operational amplifiers, attempts to measure the input bias current can result in erroneous readings. The bias current at normal room ambient temperature is typically less than 1 pA, a value that is easily exceeded by leakages on the test socket. Two suggestions are offered to avoid erroneous measurements:

- 1. Isolate the device from other potential leakage sources. Use a grounded shield around and between the device inputs (see Figure 4). Leakages that would otherwise flow to the inputs are shunted away.
- Compensate for the leakage of the test socket by actually performing an input bias current test (using a picoammeter) with no device in the test socket. The actual input bias current can then be calculated by subtracting the open-socket leakage readings from the readings obtained with a device in the test socket.

One word of caution—many automatic testers as well as some bench-top operational amplifier testers use the servo-loop technique with a resistor in series with the device input to measure the input bias current (the voltage drop across the series resistor is measured and the bias current is calculated). This method requires that a device be inserted into the test socket to obtain a correct reading; therefore, an open-socket reading is not feasible using this method.

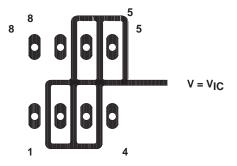


Figure 4. Isolation Metal Around Device Inputs (JG and P packages)

low-level output voltage

To obtain low-supply-voltage operation, some compromise was necessary in the input stage. This compromise results in the device low-level output being dependent on both the common-mode input voltage level as well as the differential input voltage level. When attempting to correlate low-level output readings with those quoted in the electrical specifications, these two conditions should be observed. If conditions other than these are to be used, please refer to Figures 14 through 19 in the Typical Characteristics of this data sheet.

PARAMETER MEASUREMENT INFORMATION

input offset voltage temperature coefficient

Erroneous readings often result from attempts to measure temperature coefficient of input offset voltage. This parameter is actually a calculation using input offset voltage measurements obtained at two different temperatures. When one (or both) of the temperatures is below freezing, moisture can collect on both the device and the test socket. This moisture results in leakage and contact resistance, which can cause erroneous input offset voltage readings. The isolation techniques previously mentioned have no effect on the leakage, since the moisture also covers the isolation metal itself, thereby rendering it useless. It is suggested that these measurements be performed at temperatures above freezing to minimize error.

full-power response

Full-power response, the frequency above which the operational amplifier slew rate limits the output voltage swing, is often specified two ways: full-linear response and full-peak response. The full-linear response is generally measured by monitoring the distortion level of the output while increasing the frequency of a sinusoidal input signal until the maximum frequency is found above which the output contains significant distortion. The full-peak response is defined as the maximum output frequency, without regard to distortion, above which full peak-to-peak output swing cannot be maintained.

Because there is no industry-wide accepted value for significant distortion, the full-peak response is specified in this data sheet and is measured using the circuit of Figure 1. The initial setup involves the use of a sinusoidal input to determine the maximum peak-to-peak output of the device (the amplitude of the sinusoidal wave is increased until clipping occurs). The sinusoidal wave is then replaced with a square wave of the same amplitude. The frequency is then increased until the maximum peak-to-peak output can no longer be maintained (Figure 5). A square wave is used to allow a more accurate determination of the point at which the maximum peak-to-peak output is reached.

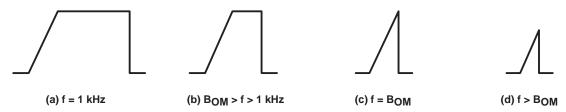


Figure 5. Full-Power-Response Output Signal

test time

Inadequate test time is a frequent problem, especially when testing CMOS devices in a high-volume, short-test-time environment. Internal capacitances are inherently higher in CMOS than in bipolar and BiFET devices and require longer test times than their bipolar and BiFET counterparts. The problem becomes more pronounced with reduced supply levels and lower temperatures.

TYPICAL CHARACTERISTICS

Table of Graphs

			FIGURE
VIO	Input offset voltage	Distribution	6, 7
αVIO	Temperature coefficient	Distribution	8, 9
Vон	High-level output voltage	vs High-level output current vs Supply voltage vs Free-air temperature	10, 11 12 13
VOL	Low-level output voltage	vs Common-mode input voltage vs Differential input voltage vs Free-air temperature vs Low-level output current	14, 15 16 17 18, 19
AVD	Differential voltage amplification	vs Supply voltage vs Free-air temperature vs Frequency	20 21 32, 33
I _{IB} /I _{IO}	Input bias and input offset current	vs Free-air temperature	22
VIC	Common-mode input voltage	vs Supply voltage	23
IDD	Supply current	vs Supply voltage vs Free-air temperature	24 25
SR	Slew rate	vs Supply voltage vs Free-air temperature	26 27
	Normalized slew rate	vs Free-air temperature	28
VO(PP)	Maximum peak-to-peak output voltage	vs Frequency	29
В ₁	Unity-gain bandwidth	vs Free-air temperature vs Supply voltage	30 31
^ф т	Phase margin	vs Supply voltage vs Free-air temperature vs Capacitive loads	34 35 36
Vn	Equivalent input noise voltage	vs Frequency	37
ф	Phase shift	vs Frequency	32, 33

TYPICAL CHARACTERISTICS

DISTRIBUTION OF TLC27M2 INPUT OFFSET VOLTAGE

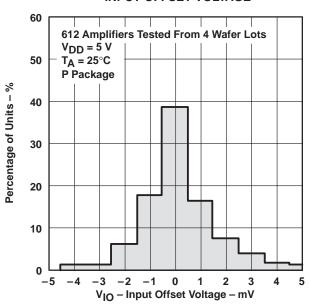


Figure 6

DISTRIBUTION OF TLC27M2 INPUT OFFSET VOLTAGE

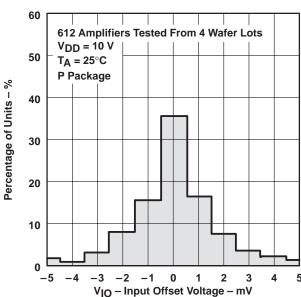


Figure 7

DISTRIBUTION OF TLC27M2 AND TLC27M7 INPUT OFFSET VOLTAGE TEMPERATURE COEFFICIENT

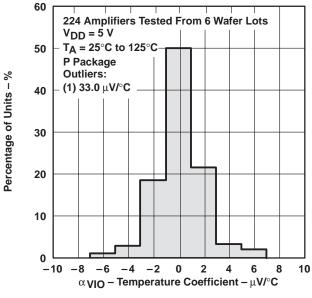


Figure 8

DISTRIBUTION OF TLC27M2 AND TLC27M7 INPUT OFFSET VOLTAGE TEMPERATURE COEFFICIENT

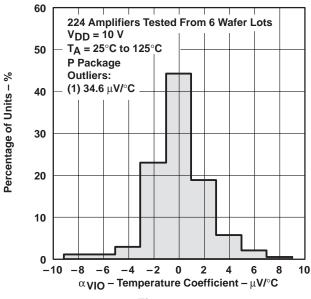
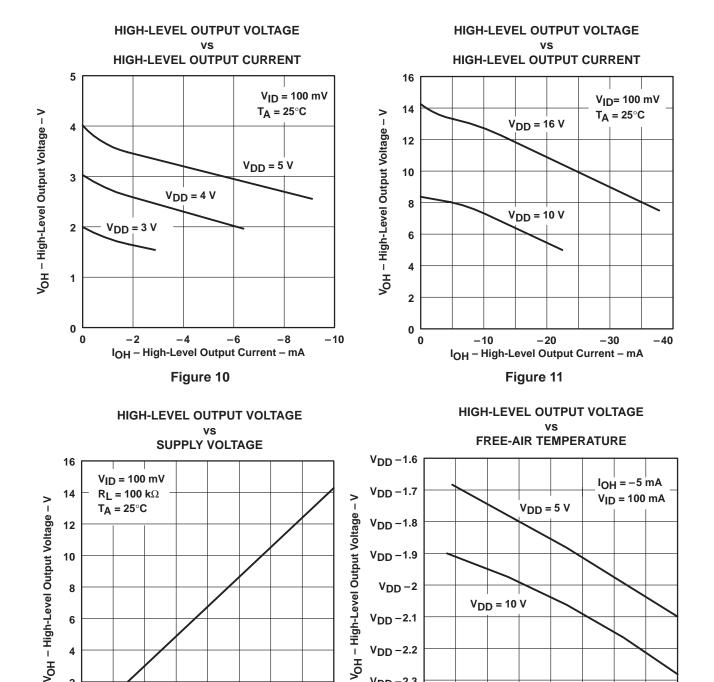


Figure 9



16

4

2

0

0

2

8

V_{DD} – Supply Voltage – V Figure 12

10

12

14



V_{DD} -2.2

V_{DD} -2.3

V_{DD} -2.4

. -75

-50

-25

0

Figure 13

25

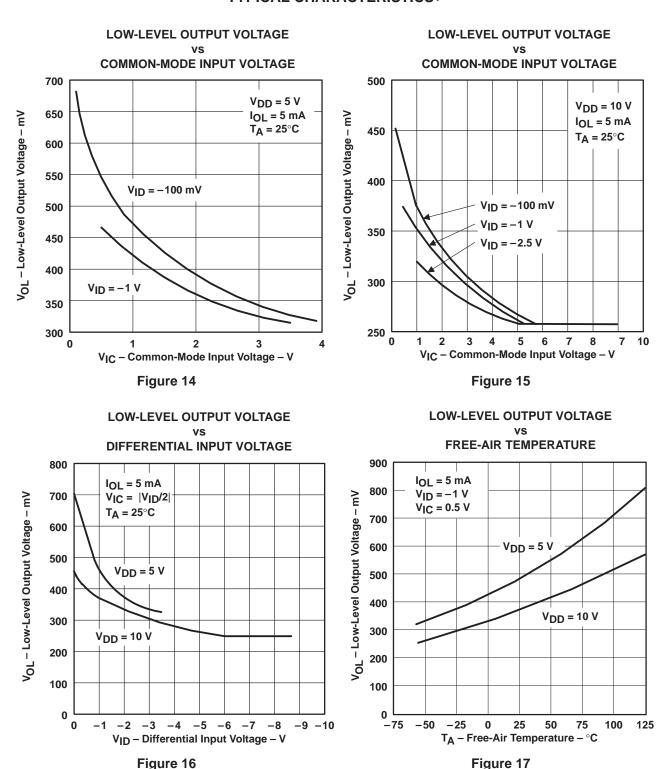
T_A – Free-Air Temperature – °C

50

75

100 125

[†] Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.



[†] Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.



TYPICAL CHARACTERISTICS†

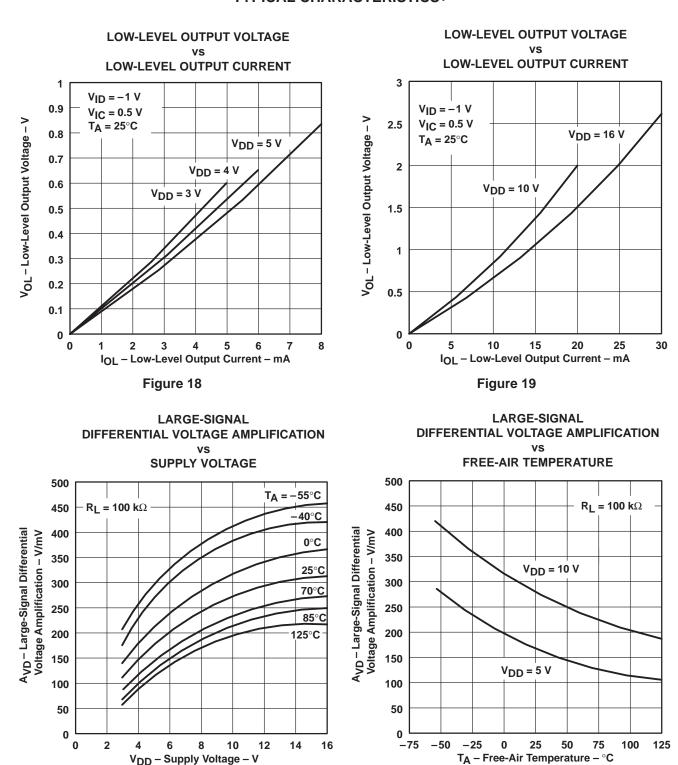


Figure 20

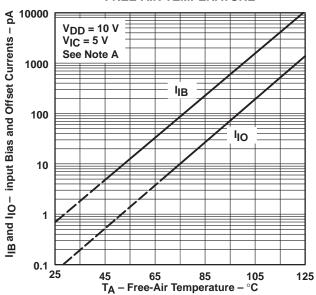


Figure 21

[†] Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

INPUT BIAS CURRENT AND INPUT OFFSET CURRENT

vs FREE-AIR TEMPERATURE



NOTE A: The typical values of input bias current and input offset current below 5 pA were determined mathematically.

Figure 22

SUPPLY CURRENT vs SUPPLY VOLTAGE

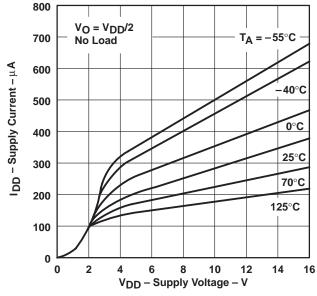


Figure 24

COMMON-MODE INPUT VOLTAGE POSITIVE LIMIT



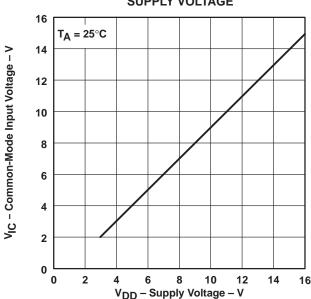


Figure 23

SUPPLY CURRENT

FREE-AIR TEMPERATURE

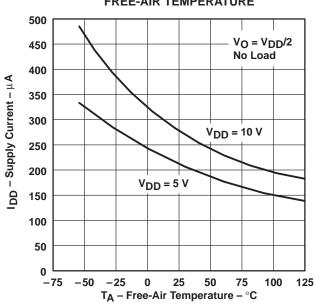
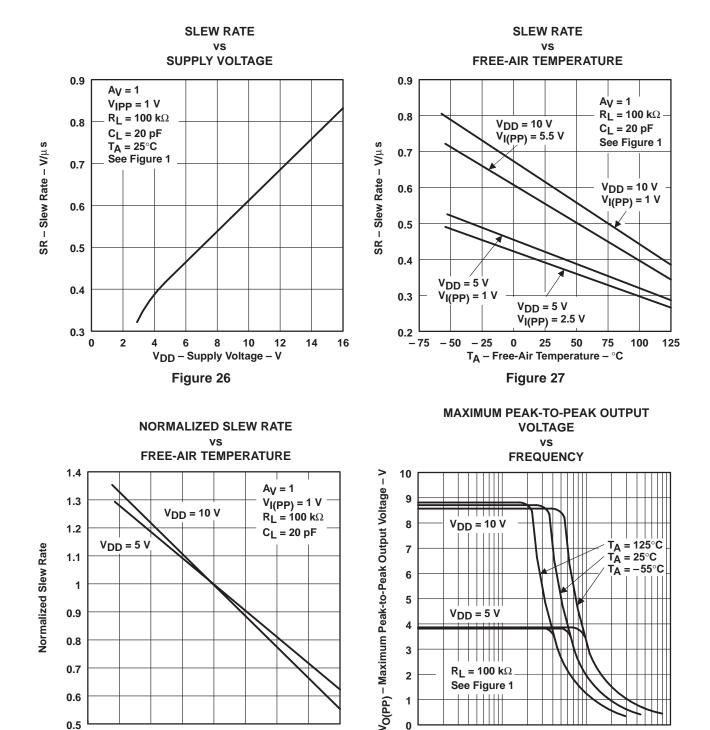


Figure 25

[†] Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.





† Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

125

0.7

0.6

0.5

_75

-50

-25

0

25

 T_A – Free-Air Temperature – $^{\circ}C$

Figure 28

50

75

100



 $R_L = 100 \text{ k}\Omega$

See Figure 1

10

f - Frequency - kHz

Figure 29

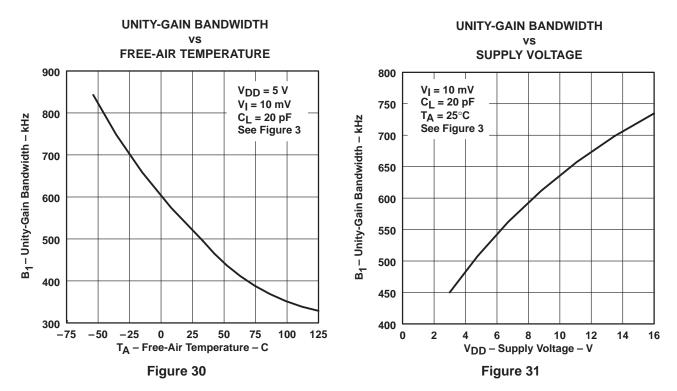
100

2

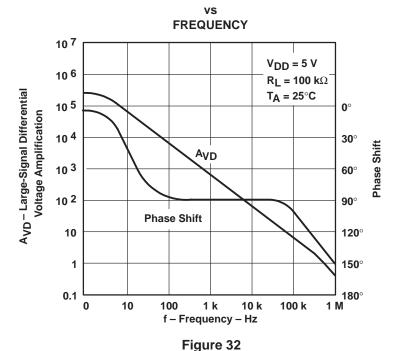
0

1

1000



LARGE-SCALE DIFFERENTIAL VOLTAGE AMPLIFICATION AND PHASE SHIFT



[†] Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.



LARGE-SCALE DIFFERENTIAL VOLTAGE AMPLIFICATION AND PHASE SHIFT

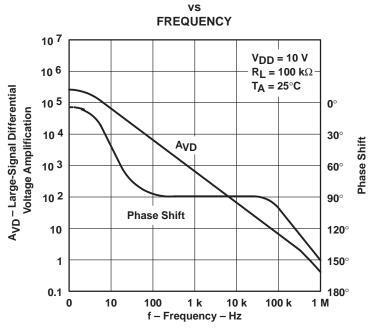
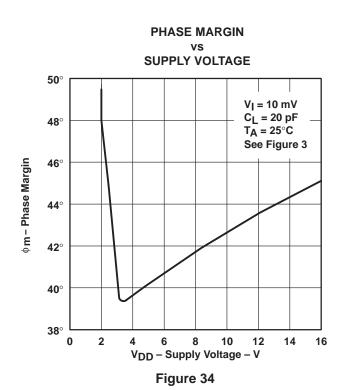


Figure 33



PHASE MARGIN vs FREE-AIR TEMPERATURE 45° $V_{DD} = 5 V$ $V_I = 10 \text{ mV}$ 43° $C_{L} = 20 \text{ pF}$ See Figure 3 om - Phase Margin **41**° $\mathbf{39}^{\circ}$ 37° 35° 100 -75 -50 -25 0 25 50 75 125 T_A - Free-Air Temperature - C

Figure 35

† Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.



TYPICAL CHARACTERISTICS

PHASE MARGIN vs CAPACITIVE LOAD

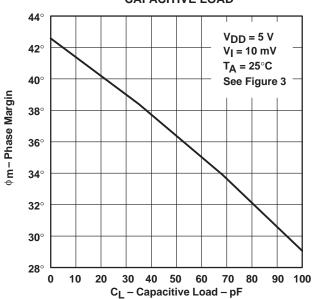


Figure 36

EQUIVALENT INPUT NOISE VOLTAGE

FREQUENCY

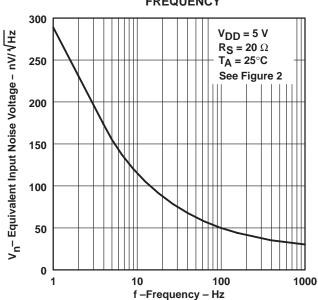


Figure 37

single-supply operation

While the TLC27M2 and TLC27M7 perform well using dual power supplies (also called balanced or split supplies), the design is optimized for single-supply operation. This design includes an input common-mode voltage range that encompasses ground as well as an output voltage range that pulls down to ground. The supply voltage range extends down to 3 V (C-suffix types), thus allowing operation with supply levels commonly available for TTL and HCMOS; however, for maximum dynamic range, 16-V single-supply operation is recommended.

Many single-supply applications require that a voltage be applied to one input to establish a reference level that is above ground. A resistive voltage divider is usually sufficient to establish this reference level (see Figure 38). The low input bias current of the TLC27M2 and TLC27M7 permits the use of very large resistive values to implement the voltage divider, thus minimizing power consumption.

The TLC27M2 and TLC27M7 work well in conjunction with digital logic; however, when powering both linear devices and digital logic from the same power supply, the following precautions are recommended:

- 1. Power the linear devices from separate bypassed supply lines (see Figure 39); otherwise, the linear device supply rails can fluctuate due to voltage drops caused by high switching currents in the digital logic.
- 2. Use proper bypass techniques to reduce the probability of noise-induced errors. Single capacitive decoupling is often adequate; however, high-frequency applications may require RC decoupling.

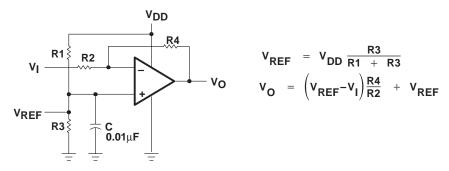
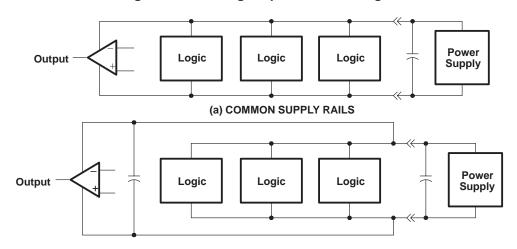


Figure 38. Inverting Amplifier With Voltage Reference



(b) SEPARATE BYPASSED SUPPLY RAILS (preferred)

Figure 39. Common Versus Separate Supply Rails



input characteristics

The TLC27M2 and TLC27M7 are specified with a minimum and a maximum input voltage that, if exceeded at either input, could cause the device to malfunction. Exceeding this specified range is a common problem, especially in single-supply operation. Note that the lower range limit includes the negative rail, while the upper range limit is specified at V_{DD} –1 V at T_A = 25°C and at V_{DD} –1.5 V at all other temperatures.

The use of the polysilicon-gate process and the careful input circuit design gives the TLC27M2 and TLC27M7 very good input offset voltage drift characteristics relative to conventional metal-gate processes. Offset voltage drift in CMOS devices is highly influenced by threshold voltage shifts caused by polarization of the phosphorus dopant implanted in the oxide. Placing the phosphorus dopant in a conductor (such as a polysilicon gate) alleviates the polarization problem, thus reducing threshold voltage shifts by more than an order of magnitude. The offset voltage drift with time has been calculated to be typically $0.1\mu V/month$, including the first month of operation.

Because of the extremely high input impedance and resulting low bias current requirements, the TLC27M2 and TLC27M7 are well suited for low-level signal processing; however, leakage currents on printed-circuit boards and sockets can easily exceed bias current requirements and cause a degradation in device performance. It is good practice to include guard rings around inputs (similar to those of Figure 4 in the Parameter Measurement Information section). These guards should be driven from a low-impedance source at the same voltage level as the common-mode input (see Figure 40).

The inputs of any unused amplifiers should be tied to ground to avoid possible oscillation.

noise performance

The noise specifications in operational amplifier circuits are greatly dependent on the current in the first-stage differential amplifier. The low input bias current requirements of the TLC27M2 and TLC27M7 result in a very low noise current, which is insignificant in most applications. This feature makes the devices especially favorable over bipolar devices when using values of circuit impedance greater than $50\,\mathrm{k}\Omega$, since bipolar devices exhibit greater noise currents.

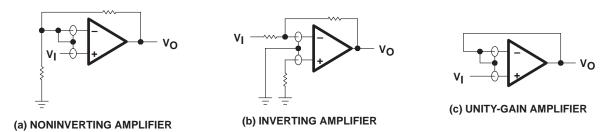


Figure 40. Guard-Ring Schemes

output characteristics

The output stage of the TLC27M2 and TLC27M7 is designed to sink and source relatively high amounts of current (see typical characteristics). If the output is subjected to a short-circuit condition, this high current capability can cause device damage under certain conditions. Output current capability increases with supply voltage.

All operating characteristics of the TLC27M2 and TLC27M7 were measured using a 20-pF load. The devices drive higher capacitive loads; however, as output load capacitance increases, the resulting response pole occurs at lower frequencies, thereby causing ringing, peaking, or even oscillation (see Figure 41). In many cases, adding a small amount of resistance in series with the load capacitance alleviates the problem.



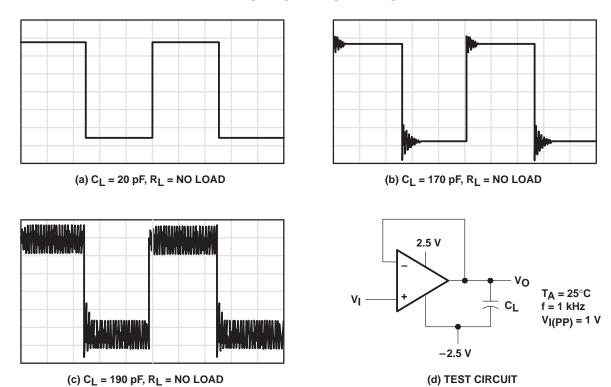
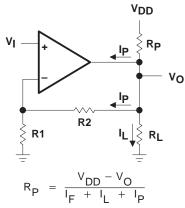


Figure 41. Effect of Capacitive Loads and Test Circuit

output characteristics (continued)

Although the TLC27M2 and TLC27M7 possess excellent high-level output voltage and current capability, methods for boosting this capability are available, if needed. The simplest method involves the use of a pullup resistor (R_P) connected from the output to the positive supply rail (see Figure 42). There are two disadvantages to the use of this circuit. First, the NMOS pulldown transistor N4 (see equivalent schematic) must sink a comparatively large amount of current. In this circuit, N4 behaves like a linear resistor with an on-resistance between approximately $60\,\Omega$ and $180\,\Omega$, depending on how hard the op amp input is driven. With very low values of R_P, a voltage offset from 0 V at the output occurs. Second, pullup resistor R_P acts as a drain load to N4 and the gain of the operational amplifier is reduced at output voltage levels where N5 is not supplying the output current.

output characteristics (continued)



Ip = Pullup current required by the operational amplifier (typically 500 μ A)

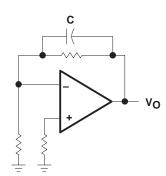


Figure 42. Resistive Pullup to Increase VOH

Figure 43. Compensation for Input Capacitance

feedback

Operational amplifier circuits nearly always employ feedback, and since feedback is the first prerequisite for oscillation, some caution is appropriate. Most oscillation problems result from driving capacitive loads (discussed previously) and ignoring stray input capacitance. A small-value capacitor connected in parallel with the feedback resistor is an effective remedy (see Figure 43). The value of this capacitor is optimized empirically.

electrostatic-discharge protection

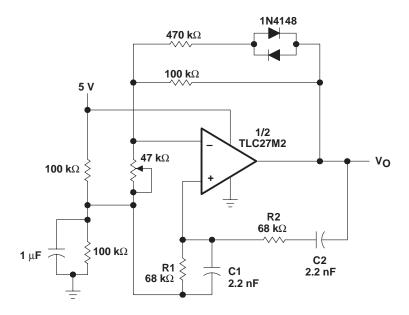
The TLC27M2 and TLC27M7 incorporate an internal electrostatic-discharge (ESD) protection circuit that prevents functional failures at voltages up to 2000 V as tested under MIL-STD-883C, Method 3015.2. Care should be exercised, however, when handling these devices as exposure to ESD may result in the degradation of the device parametric performance. The protection circuit also causes the input bias currents to be temperature dependent and have the characteristics of a reverse-biased diode.

latch-up

Because CMOS devices are susceptible to latch-up due to their inherent parasitic thyristors, the TLC27M2 and TLC27M7 inputs and outputs were designed to withstand -100-mA surge currents without sustaining latch-up; however, techniques should be used to reduce the chance of latch-up whenever possible. Internal protection diodes should not, by design, be forward biased. Applied input and output voltage should not exceed the supply voltage by more than 300 mV. Care should be exercised when using capacitive coupling on pulse generators. Supply transients should be shunted by the use of decoupling capacitors (0.1 μ F typical) located across the supply rails as close to the device as possible.

The current path established if latch-up occurs is usually between the positive supply rail and ground and can be triggered by surges on the supply lines and/or voltages on either the output or inputs that exceed the supply voltage. Once latch-up occurs, the current flow is limited only by the impedance of the power supply and the forward resistance of the parasitic thyristor and usually results in the destruction of the device. The chance of latch-up occurring increases with increasing temperature and supply voltages.

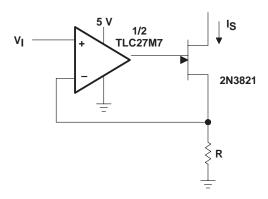




NOTES:
$$V_{O(PP)} \approx 2 \text{ V}$$

$$f_{O} = \frac{1}{2\pi\sqrt{R1R2C1C2}}$$

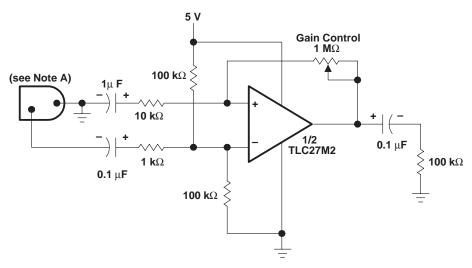
Figure 44. Wien Oscillator



NOTES:
$$V_I = 0 \text{ V to } 3 \text{ V}$$

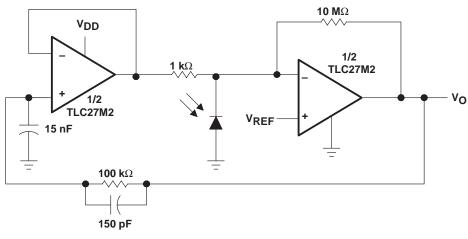
$$I_S = \frac{V_I}{R}$$

Figure 45. Precision Low-Current Sink



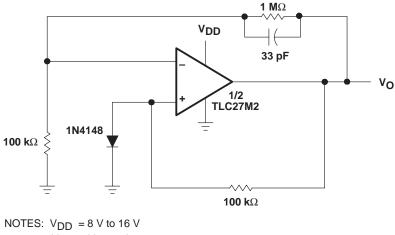
NOTE A: Low to medium impedance dynamic mike

Figure 46. Microphone Preamplifier



NOTES: $V_{DD} = 4 \text{ V to } 15 \text{ V}$ $V_{ref} = 0 \text{ V to } V_{DD} - 2 \text{ V}$

Figure 47. Photo-Diode Amplifier With Ambient Light Rejection



 $V_0 = 5 \text{ V}, 10 \text{ mA}$

Figure 48. 5-V Low-Power Voltage Regulator

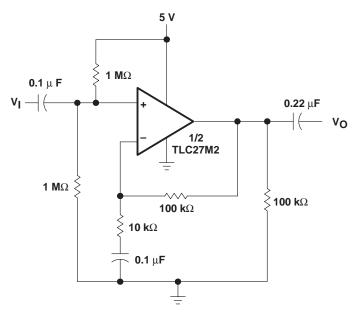


Figure 49. Single-Rail AC Amplifiers



PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
TLC27M2ACD	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC27M2ACDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC27M2ACP	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLC27M2ACPE4	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLC27M2AID	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC27M2AIDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC27M2AIP	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLC27M2AIPE4	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLC27M2BCD	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC27M2BCDG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC27M2BCDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC27M2BCP	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLC27M2BCPE4	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLC27M2BCPSR	ACTIVE	SO	PS	8	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1YEAR/ Level-1-220C-UNLIM
TLC27M2BID	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC27M2BIDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC27M2BIDRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC27M2BIP	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLC27M2BIPE4	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLC27M2CD	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC27M2CDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC27M2CP	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLC27M2CPE4	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLC27M2CPSLE	OBSOLETE	SO	PS	8		TBD	Call TI	Call TI
TLC27M2CPSR	ACTIVE	SO	PS	8	2000	TBD	CU NIPDAU	Level-1-220C-UNLIM
TLC27M2CPW	ACTIVE	TSSOP	PW	8	150	TBD		Level-1-220C-UNLIM
. 2027 191201 99	, (O11VL	. 5551		5	100	, 55	00 Mil DA0	LUTUR 1 ZZUU UNLIM





14-Jun-2005

TLC27M2CPWLE		Type	Drawing		Qty			MSL Peak Temp ⁽³⁾
	OBSOLETE	TSSOP	PW	8		TBD	Call TI	Call TI
TLC27M2CPWR	ACTIVE	TSSOP	PW	8	2000	TBD	CU NIPDAU	Level-1-220C-UNLIM
TLC27M2ID	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC27M2IDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC27M2IP	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLC27M2IPE4	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLC27M2IPW	ACTIVE	TSSOP	PW	8	150	TBD	CU NIPDAU	Level-1-220C-UNLIM
TLC27M2IPWR	ACTIVE	TSSOP	PW	8	2000	TBD	CU NIPDAU	Level-1-220C-UNLIM
TLC27M2MD	ACTIVE	SOIC	D	8	75	TBD	CU NIPDAU	Level-1-220C-UNLIM
TLC27M2MDR	ACTIVE	SOIC	D	8	2500	TBD	Call TI	Call TI
TLC27M2MFKB	OBSOLETE	LCCC	FK	20		TBD	Call TI	Call TI
TLC27M2MJG	OBSOLETE	CDIP	JG	8		TBD	Call TI	Call TI
TLC27M2MJGB	OBSOLETE	CDIP	JG	8		TBD	Call TI	Call TI
TLC27M7CD	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC27M7CDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC27M7CP	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLC27M7CPE4	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLC27M7CPSR	ACTIVE	so	PS	8	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1YEAR/ Level-1-220C-UNLIM
TLC27M7ID	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC27M7IDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC27M7IDRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC27M7IP	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLC27M7IPE4	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLC27M7MFKB	OBSOLETE	LCCC	FK	20		TBD	Call TI	Call TI
TLC27M7MJG	OBSOLETE	CDIP	JG	8		TBD	Call TI	Call TI
TLC27M7MJGB	OBSOLETE	CDIP	JG	8		TBD	Call TI	Call TI
TLC27M7MUB	OBSOLETE	CFP	U	10		TBD	Call TI	Call TI

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.



PACKAGE OPTION ADDENDUM

14-Jun-2005

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

JG (R-GDIP-T8)

CERAMIC DUAL-IN-LINE

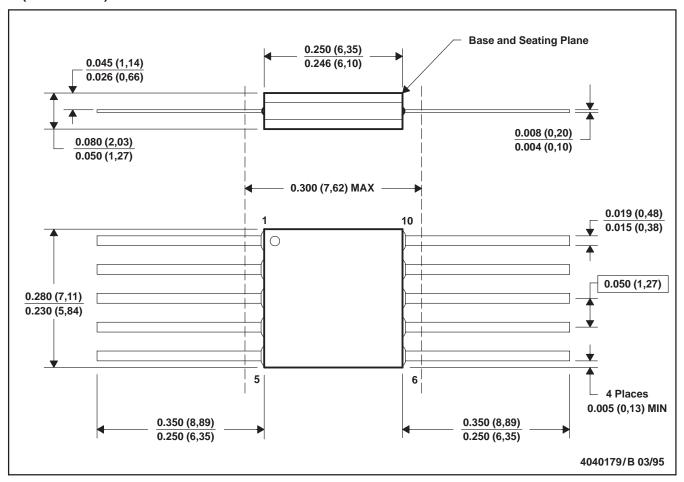


NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification.
- E. Falls within MIL STD 1835 GDIP1-T8

U (S-GDFP-F10)

CERAMIC DUAL FLATPACK



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F10 and JEDEC MO-092AA

FK (S-CQCC-N**)

28 TERMINAL SHOWN

LEADLESS CERAMIC CHIP CARRIER



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004



P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-001

For the latest package information, go to $http://www.ti.com/sc/docs/package/pkg_info.htm$

D (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AA.





NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



PW (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DSP	dsp.ti.com	Broadband	www.ti.com/broadband
Interface	interface.ti.com	Digital Control	www.ti.com/digitalcontrol
Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
		Telephony	www.ti.com/telephony
		Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless

Mailing Address: Texas Instruments

Post Office Box 655303 Dallas, Texas 75265

Copyright © 2005, Texas Instruments Incorporated